

Silicon Tuning Diode

This device is designed in the Surface Mount package for general frequency control and tuning applications. It provides solid–state reliability in replacement of mechanical tuning methods.

ORDERING INFORMATION

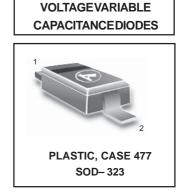
Package

SOD-323

- Controlled and Uniform Tuning Ratio
- Device Marking: M4E

Device

MMVL105GT1



MMVL105GT1

30 VOLT

1 O	 -0	2	
CATHODE	A	NODE	-

MAXIMUM RATINGS

Symbol	Rating	Value	Unit	
V _R	Continuous Reverse Voltage	30	Vdc	
I _F	Peak Forward Current	200	mAdc	

Shipping

3000 / Tape & Reel

THERMAL CHARACTERISTICS

Symbol	Characteristic	Мах	Unit
PD	Total Device Dissipation FR-5 Board,*	200	mW
	$T_A = 25^{\circ}C$		
	Derate above 25°C	1.57	mW/°C
$R_{ ext{ heta}JA}$	Themal Resistance Junction toAmbient	635	°C/W
TJ, Tstg	Junction and Storage Temperature	150	°C

*FR-4 Minimum Pad

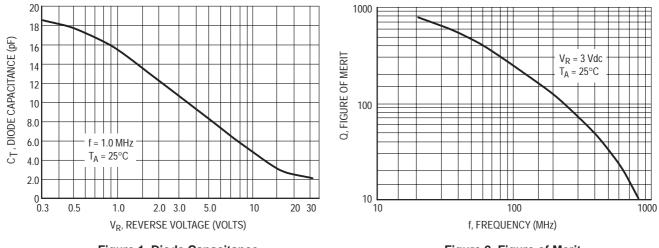
ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit	
Reverse BreakdownVoltage	V _{(BR)R}	30	—	Vdc	
(I _R = 10 μAdc)					
Reverse Voltage Leakage Current	I _R	_	50	nAdc	
$(V_{R} = 28 \text{ Vdc})$					

	Ct		Q	(C _R ,
	V _R = 25 Vdc, f = 1.0 MHz pF		V _R = 3.0 Vdc	C	3/C ₂₅
			f = 50 MHz	f = 1.0 MHz	
Device Type	Min	Мах	Тур	Min	Max
MMVL105T1	1.5	2.8	250	4.0	6.5



MMVL105GT1



TYPICAL CHARACTERISTICS



Figure 2. Figure of Merit

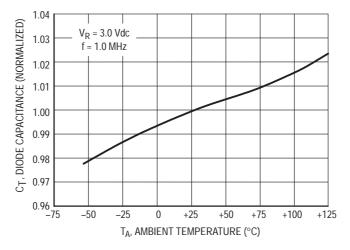


Figure 3. Diode Capacitance